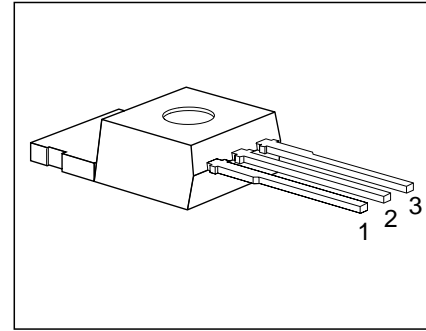


### Features

- N channel
- Enhancement mode
- Temperature sensor with thyristor characteristic
- The drain pin is electrically shorted to the tab



| Pin | 1 | 2 | 3 |
|-----|---|---|---|
|     | G | D | S |

| Type    | $V_{DS}$ | $I_D$ | $R_{DS(on)}$  | Package  | Ordering Code   |
|---------|----------|-------|---------------|----------|-----------------|
| BTS 130 | 50 V     | 27 A  | 0.05 $\Omega$ | TO-220AB | C67078-A5001-A3 |

### Maximum Ratings

| Parameter   | Symbol                                     | Values                   | Unit              |
|---|--|--------------------------|-------------------|
| Drain-source voltage  | $V_{DS}$                                   | 50                       | V                 |
| Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$   | $V_{DGR}$                                  | 50                       |                   |
| Gate-source peak voltage, aperiodic   | $V_{gs}$                                   | $\pm 20$                 |                   |
| Continuous drain current, $T_C = 25^\circ \text{C}$   | $I_D$                                      | 27                       | A                 |
| ISO drain current<br>$T_C = 85^\circ \text{C}$ , $V_{GS} = 10 \text{ V}$ , $V_{DS} = 0.5 \text{ V}$ | $I_{D-ISO}$                                | 7.5                      |                   |
| Pulsed drain current, $T_C = 25^\circ \text{C}$   | $I_{D \text{ puls}}$                       | 108                      |                   |
| Short circuit current, $T_j = -55 \dots +150^\circ \text{C}$  | $I_{SC}$                                   | 80                       |                   |
| Short circuit dissipation, $T_j = -55 \dots +150^\circ \text{C}$                                    | $P_{SCmax}$                                | 1200                     | W                 |
| Power dissipation   | $P_{tot}$                                  | 75                       |                   |
| Operating and storage temperature range   | $T_j, T_{stg}$                             | $-55 \dots +150$         | $^\circ \text{C}$ |
| DIN humidity category, DIN 40 040   | –  | E                        | –                 |
| IEC climatic category, DIN IEC 68-1   | –  | 55/150/56                |                   |
| Thermal resistance<br>Chip-case<br>Chip-ambient   | $R_{th \text{ JC}}$<br>$R_{th \text{ JA}}$ | $\leq 1.67$<br>$\leq 75$ | K/W               |

## Electrical Characteristics

at  $T_j = 25\text{ °C}$ , unless otherwise specified.

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

## Static Characteristics

|   |               |     |          |           |                     |
|---|---------------|-----|----------|-----------|---------------------|
| Drain-source breakdown voltage<br>$V_{GS} = 0, I_D = 0.25\text{ mA}$  | $V_{(BR)DSS}$ | 50  | –        | –         | V                   |
| Gate threshold voltage<br>$V_{GS} = V_{DS}, I_D = 1\text{ mA}$  | $V_{GS(th)}$  | 2.5 | 3.0      | 3.5       |                     |
| Zero gate voltage drain current<br>$V_{GS} = 0\text{ V}, V_{DS} = 50\text{ V}$<br>$T_j = 25\text{ °C}$<br>$T_j = 125\text{ °C}$ | $I_{DSS}$     | –   | 1<br>100 | 10<br>300 | $\mu\text{A}$       |
| Gate-source leakage current<br>$V_{GS} = 20\text{ V}, V_{DS} = 0$<br>$T_j = 25\text{ °C}$<br>$T_j = 150\text{ °C}$              | $I_{GSS}$     | –   | 10<br>2  | 100<br>4  | nA<br>$\mu\text{A}$ |
| Drain-source on-state resistance<br>$V_{GS} = 10\text{ V}, I_D = 17\text{ A}$   | $R_{DS(on)}$  | –   | 0.04     | 0.05      | $\Omega$            |

## Dynamic Characteristics

|   |              |     |      |      |             |
|---|--------------|-----|------|------|-------------|
| Forward transconductance<br>$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}, I_D = 17\text{ A}$  | $g_{fs}$     | 8.0 | 13.0 | 18.0 | S           |
| Input capacitance<br>$V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$   | $C_{iss}$    | 700 | 940  | 1250 | $\text{pF}$ |
| Output capacitance<br>$V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$  | $C_{oss}$    | –   | 500  | 750  |             |
| Reverse transfer capacitance<br>$V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$  | $C_{rss}$    | –   | 180  | 270  |             |
| Turn-on time $t_{on}$ , ( $t_{on} = t_{d(on)} + t_r$ )<br>$V_{CC} = 30\text{ V}, V_{GS} = 10\text{ V}, I_D = 3\text{ A}, R_{GS} = 50\text{ }\Omega$     | $t_{d(on)}$  | –   | 25   | 40   | ns          |
|   | $t_r$        | –   | 60   | 90   |             |
| Turn-off time $t_{off}$ , ( $t_{off} = t_{d(off)} + t_f$ )<br>$V_{CC} = 30\text{ V}, V_{GS} = 10\text{ V}, I_D = 3\text{ A}, R_{GS} = 50\text{ }\Omega$ | $t_{d(off)}$ | –   | 100  | 130  |             |
|   | $t_f$        | –   | 75   | 95   |             |

## Electrical Characteristics (cont'd)

at  $T_j = 25\text{ °C}$ , unless otherwise specified.

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

### Reverse Diode

|   |          |   |     |     |               |
|---|----------|---|-----|-----|---------------|
| Continuous source current   | $I_S$    | – | –   | 27  | A             |
| Pulsed source current   | $I_{SM}$ | – | –   | 108 |               |
| Diode forward on-voltage<br>$I_F = 54\text{ A}$ , $V_{GS} = 0$                                      | $V_{SD}$ | – | 1.5 | 2.0 | V             |
| Reverse recovery time<br>$I_F = I_S$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$   | $t_{rr}$ | – | 150 | –   | ns            |
| Reverse recovery charge<br>$I_F = I_S$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$ | $Q_{rr}$ | – | 1.0 | –   | $\mu\text{C}$ |

### Temperature Sensor

|   |              |      |     |     |               |
|---|--------------|------|-----|-----|---------------|
| Forward voltage<br>$I_{TS(on)} = 10\text{ mA}$ , $T_j = -55 \dots +150\text{ °C}$<br>Sensor override, $t_p \leq 100\text{ }\mu\text{s}$<br>$T_j = -55 \dots +160\text{ °C}$ | $V_{TS(on)}$ | –    | 1.4 | 1.5 | V             |
|   |              | –    | –   | 10  |               |
| Forward current<br>$T_j = -55 \dots +150\text{ °C}$<br>Sensor override, $t_p \leq 100\text{ }\mu\text{s}$<br>$T_j = -55 \dots +160\text{ °C}$                               | $I_{TS(on)}$ | –    | –   | 10  | mA            |
|   |              | –    | –   | 600 |               |
| Holding current, $V_{TS(off)} = 5\text{ V}$ ,<br>$T_j = 25\text{ °C}$<br>$T_j = 150\text{ °C}$  | $I_H$        | 0.05 | 0.1 | 0.5 |               |
|   |              | 0.05 | 0.2 | 0.3 |               |
| Switching temperature<br>$V_{TS} = 5\text{ V}$  | $T_{TS(on)}$ | 150  | –   | –   | $\text{°C}$   |
| Turn-off time<br>$V_{TS} = 5\text{ V}$ , $I_{TS(on)} = 2\text{ mA}$   | $t_{off}$    | 0.5  | –   | 2.5 | $\mu\text{s}$ |

### Examples for short-circuit protection

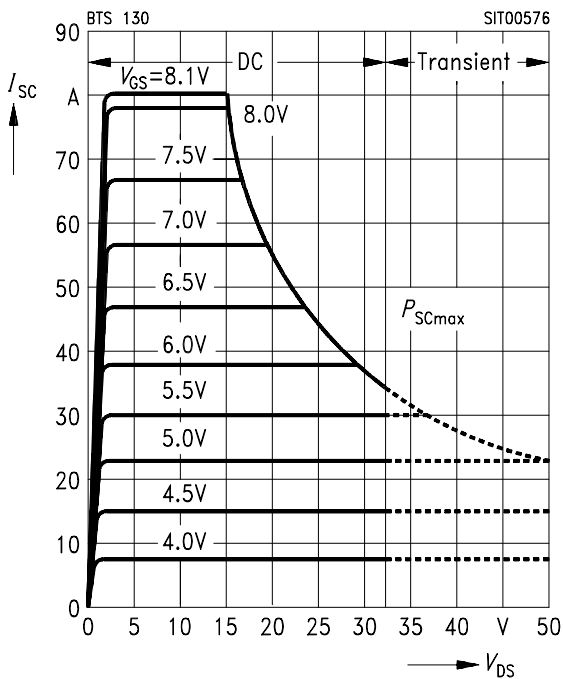
at  $T_j = -55 \dots +150 \text{ }^\circ\text{C}$ , unless otherwise specified.

| Parameter   | Symbol        | Examples  |           |   | Unit |
|---|---------------|-----------|-----------|---|------|
|   |               | 1         | 2         | – |      |
| Drain-source voltage  | $V_{DS}$      | 15        | 30        | – | V    |
| Gate-source voltage   | $V_{GS}$      | 8.1       | 5.9       | – |      |
| Short-circuit current   | $I_{SC}$      | $\leq 80$ | $\leq 37$ | – | A    |
| Short-circuit dissipation   | $P_{SC}$      | 1200      | 1100      | – | W    |
| Response time<br>$T_j = 25 \text{ }^\circ\text{C}$ , before short circuit | $t_{SC(off)}$ | 25        | 25        | – | ms   |

### Short-circuit protection $I_{SC} = f(V_{DS})$

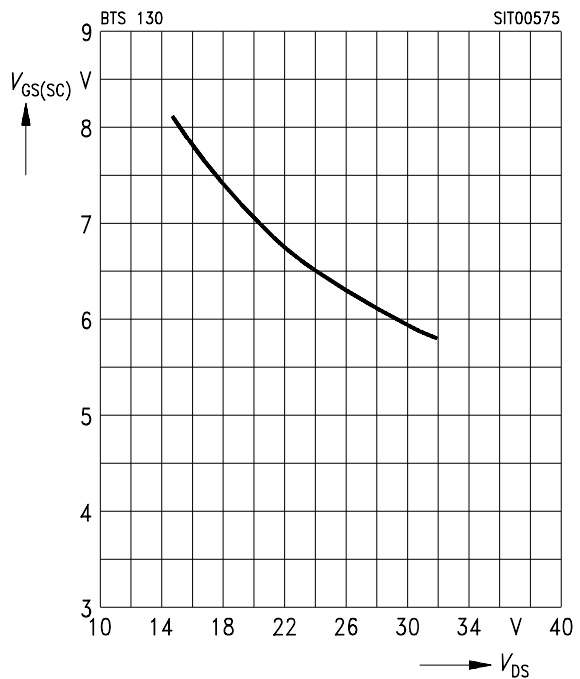
Parameter:  $V_{GS}$

Diagram to determine  $I_{SC}$  for  $T_j = -55 \dots +150 \text{ }^\circ\text{C}$

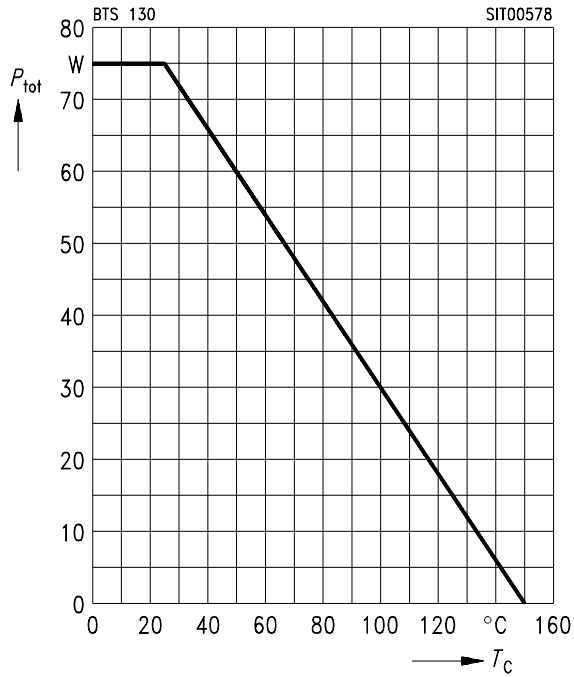


### Max. gate voltage $V_{GS(SC)} = f(V_{DS})$

Parameter:  $T_j = -55 \dots +150 \text{ }^\circ\text{C}$

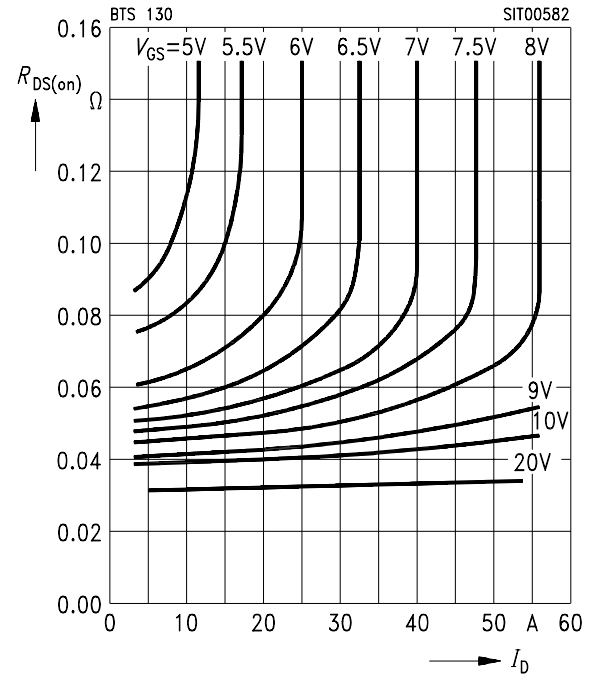


Max. power dissipation  $P_{tot} = f(T_C)$



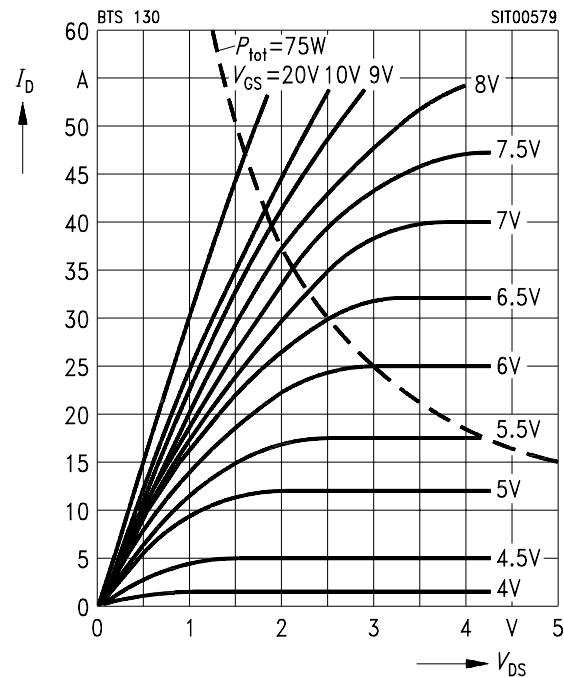
Typ. drain-source on-state resistance  $R_{DS(on)} = f(I_D)$

Parameter:  $V_{GS}$



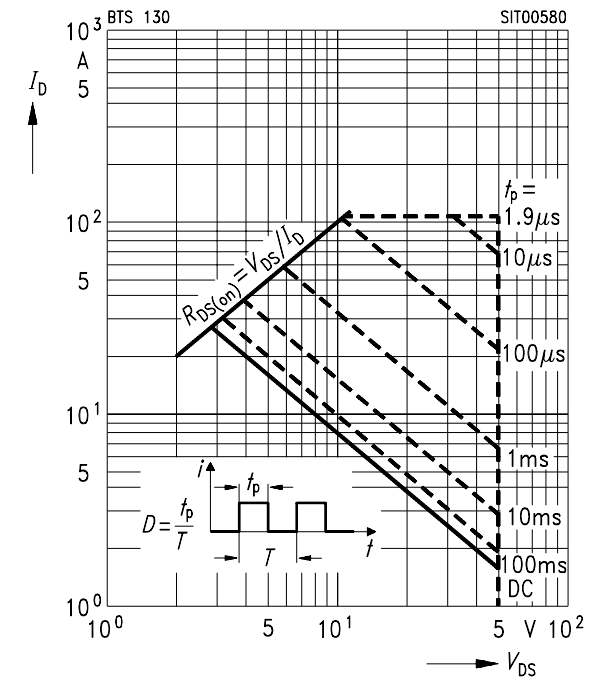
Typical output characteristics  $I_D = f(V_{DS})$

Parameter:  $t_p = 80 \mu s$



Safe operating area  $I_D = f(V_{DS})$

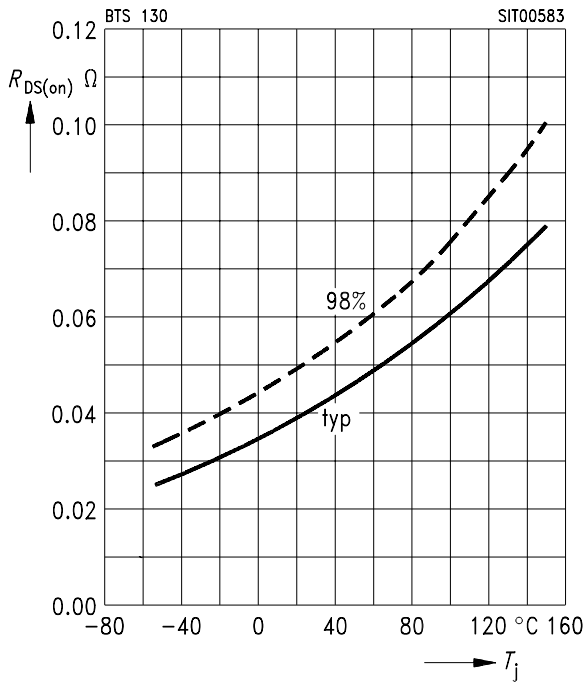
Parameter:  $D = 0.01, T_C = 25^\circ C$



**Drain-source on-state resistance**

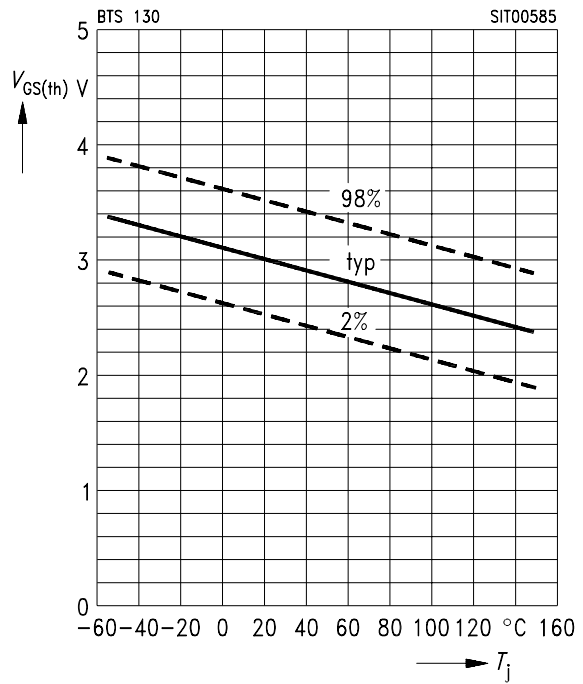
$R_{DS(on)} = f(T_j)$

Parameter:  $I_D = 17\text{ A}$ ,  $V_{GS} = 10\text{ V}$  (spread)



**Gate threshold voltage  $V_{GS(th)} = f(T_j)$**

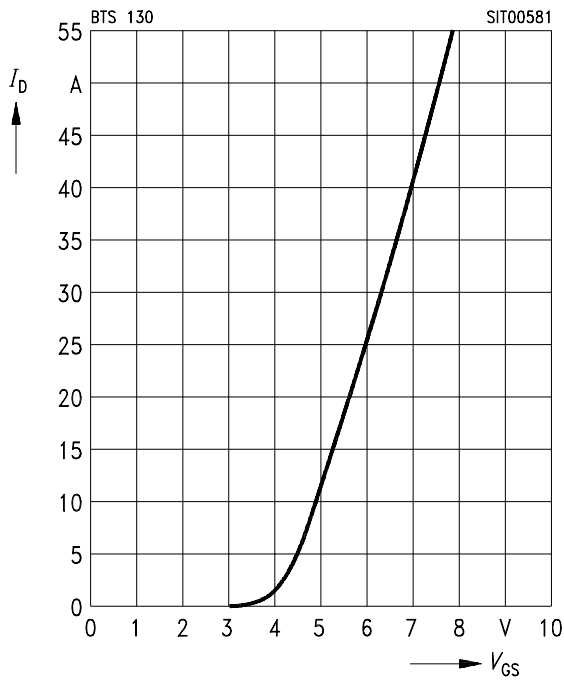
Parameter:  $V_{DS} = V_{GS}$ ,  $I_D = 1\text{ mA}$



**Typ. transfer characteristic**

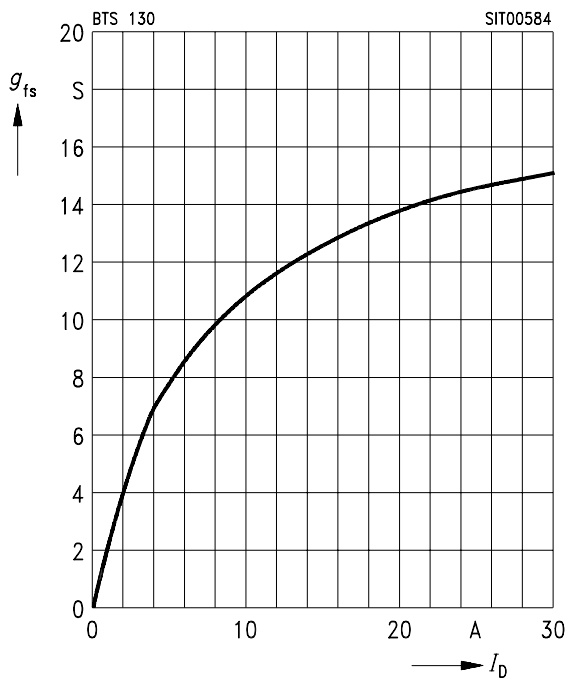
$I_D = f(V_{GS})$

Parameter:  $t_p = 80\text{ }\mu\text{s}$ ,  $V_{DS} = 25\text{ V}$



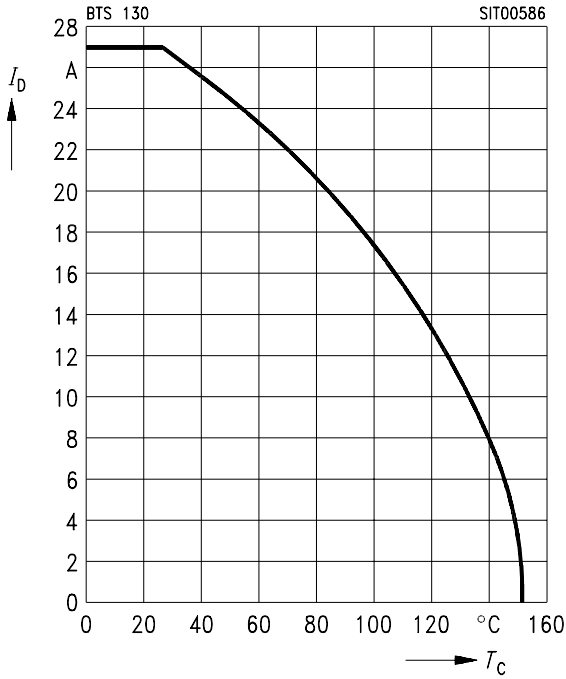
**Typ. transconductance  $g_{fs} = f(I_D)$**

Parameter:  $t_p = 80\text{ }\mu\text{s}$ ,  $V_{DS} = 25\text{ V}$



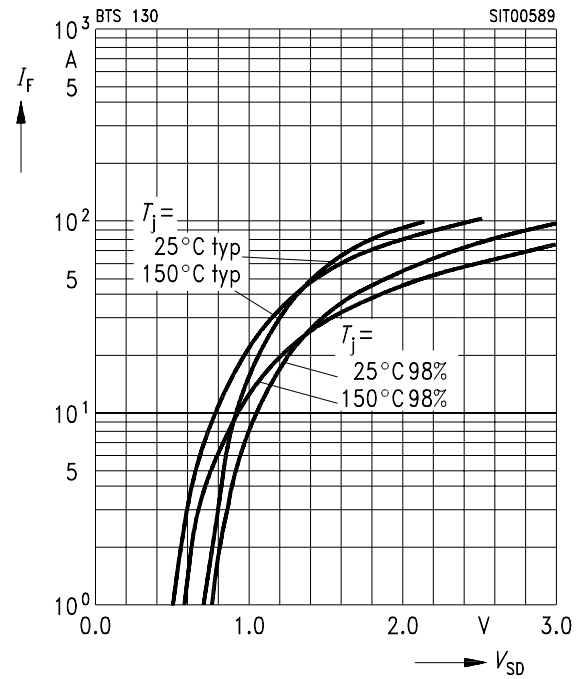
**Continuous drain current  $I_D = f(T_C)$**

Parameter:  $V_{GS} \geq 10\text{ V}$



**Forward characteristics of reverse diode  $I_F = f(V_{SD})$**

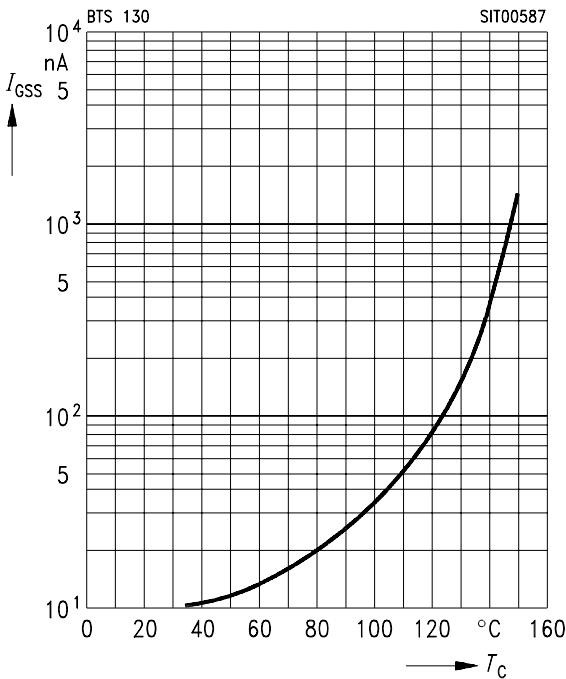
Parameter:  $T_j, t_p = 80\ \mu\text{s}$  (spread)



**Typ. gate-source leakage current  $I_{GSS} = f(T_C)$**

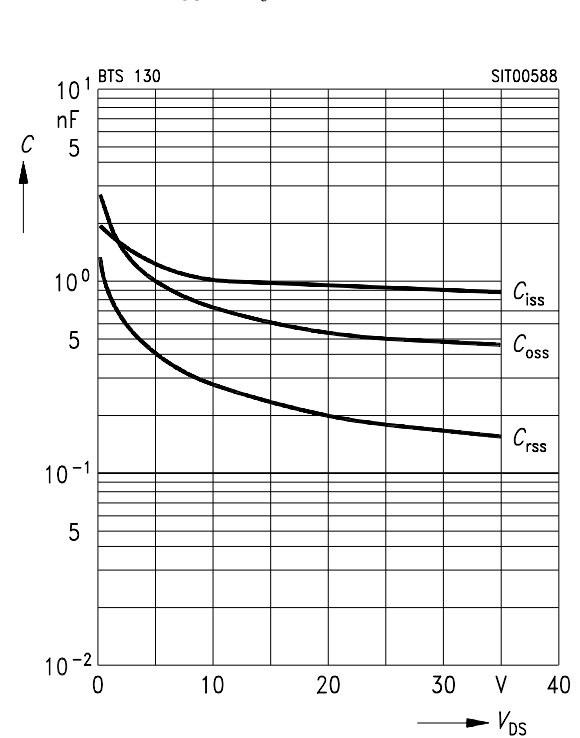
Parameter:  $V_{GS} = 20\text{ V}, V_{DS} = 0$

Parameter:  $V_{GS} = 20\text{ V}, V_{DS} = 0$



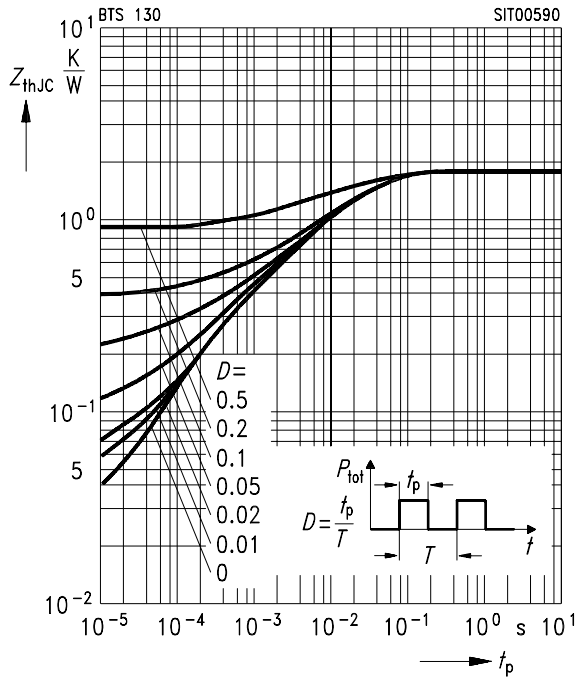
**Typ. capacitances  $C = f(V_{DS})$**

Parameter:  $V_{GS} = 0, f = 1\text{ MHz}$



**Transient thermal impedance**  $Z_{thJC} = f(t_p)$

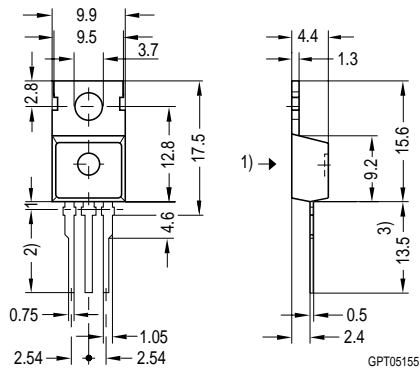
Parameter:  $D = t_p/T$





**TO 220 AB**  
Standard

**Ordering Code**  
C67078-A5001-A3

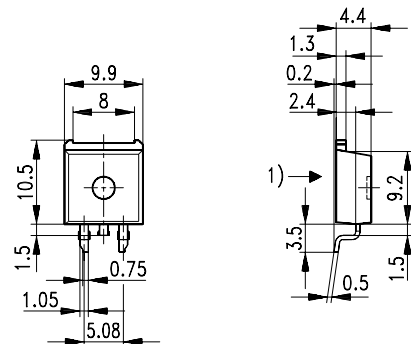


GPT05155

- 1) punch direction, burr max. 0.04
- 2) dip tinning
- 3) max. 14.5 by dip tinning press burr max. 0.05

**TO 220 AB**  
SMD version E3045

**Ordering Code**  
C67078-A5001-A9



GPD05164

- 1) shear and punch direction no burrs this surface